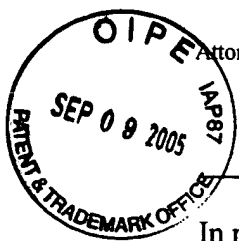


JPW



Attorney Docket # 5405-9

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of

Yuusuke KAWAHARA et al.

Serial No.: 10/668,777

Filed: September 22, 2003

For: Manufacturing Method of Circuit Substrate,
Circuit Substrate and Manufacturing Device of
Circuit Substrate

Examiner: TRINH, Michael M.
Group Art: 2822

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on

September 6, 2005

(Date of Deposit)

Thomas Langer

Name of applicant, assignee or Registered Representative

Thomas Langer

Signature

September 6, 2005

Date of Signature

Mail Stop **Amendment**
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT

SIR:

In response to the Office Action dated June 3, 2005, please amend the above-identified application as follows:

Amendments to the Specification begin on page 2 of this paper.

Amendments to the Claims are reflected in the listing of claims which begins on page 4 of this paper.

Amendments to the Drawings being on page 7 of this paper.

Remarks/Arguments begin on page 8 of this paper.